# **MPN3404**

# **Silicon Pin Diode**

This device is designed primarily for VHF band switching applications but is also suitable for use in general–purpose switching circuits. It is supplied in a cost–effective TO–92 type plastic package for economical, high–volume consumer and industrial requirements.

#### **Features**

- Rugged PIN Structure Coupled with Wirebond Construction for Optimum Reliability
- Low Series Resistance @ 100 MHz:  $R_S = 0.7 \Omega$  (Typ) @  $I_F = 10 \text{ mAdc}$
- Sturdy TO-92 Style Package for Handling Ease
- Pb-Free Packages are Available\*



Rating	Symbol	Value	Unit
Reverse Voltage	V <sub>R</sub>	20	Vdc
Forward Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	400 4.0	mW mW/°C
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μAdc)	V <sub>(BR)R</sub>	20	-	-	Vdc
Diode Capacitance (V <sub>R</sub> = 15 Vdc, f = 1.0 MHz)	C <sub>T</sub>	-	1.3	2.0	pF
Series Resistance (Figure 5) (I <sub>F</sub> = 10 mAdc)	R <sub>S</sub>	-	0.7	0.85	Ω
Reverse Leakage Current (V <sub>R</sub> = 15 Vdc)	I <sub>R</sub>	-	-	0.1	μAdc



# ON Semiconductor®

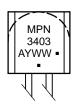
http://onsemi.com





TO-92 (TO-226AC) CASE 182-06 STYLE 1

## **MARKING DIAGRAM**



A = Assembly Location

′ = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping
MPN3404	TO-92	1000 Units / Bulk
MPN3404G	TO-92 (Pb-Free)	1000 Units / Bulk

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **MPN3404**

# **TYPICAL CHARACTERISTICS**

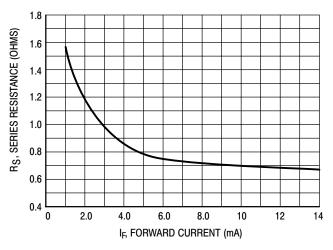
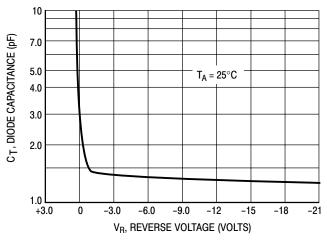


Figure 1. Series Resistance

Figure 2. Forward Voltage



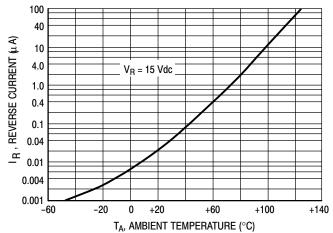


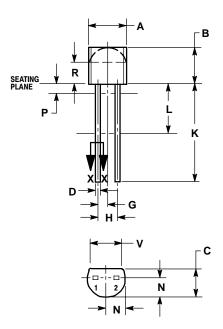
Figure 3. Diode Capacitance

Figure 4. Leakage Current

# MPN3404

#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 182-06 **ISSUE L** 





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. CONTOUR OF PACKAGE BEYOND ZONE R IS UNCONTROLLED
- 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.21	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.050 BSC		1.27 BSC		
Н	0.100 BSC		2.54 BSC		
J	0.014	0.016	0.36	0.41	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.03	2.66	
P		0.050		1.27	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 1: PIN 1. ANODE 2. CATHODE

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